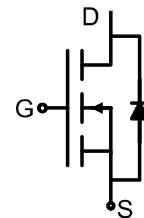


## Feature

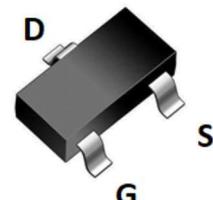
- 30V,8A
- $R_{DS(ON)} < 12m\Omega @ V_{GS}=10V$  TYP:9.8m $\Omega$
- $R_{DS(ON)} < 16m\Omega @ V_{GS}=4.5V$  TYP:13.5 m $\Omega$
- Advanced Trench Technology
- Lead free product is acquired
- Excellent  $R_{DS(ON)}$  and Low Gate Charge



Schematic Diagram

## Application

- PWM applications
- Load Switch
- Power management



SOT-23-3 top view

## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
3100	AP3100A	SOT23-3	7 inch	-	3000

## ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current ( $T_a = 25^\circ C$ )	$I_D$	8	A
Continuous Drain Current ( $T_a = 100^\circ C$ )	$I_D$	6.2	A
Pulsed Drain Current <sup>(1)</sup>	$I_{DM}$	40	A
Power Dissipation	$P_D$	1.6	W
Thermal Resistance from Junction to Ambient <sup>(3)</sup>	$R_{\theta JA}$	78	°C/W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55~+150	°C

**MOSFET ELECTRICAL CHARACTERISTICS( $T_a=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	30	-	-	V
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1	$\mu\text{A}$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	$\pm 100$	nA
Gate threshold voltage <sup>(2)</sup>	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	1.5	2.5	V
Drain-source on-resistance <sup>(2)</sup>	$R_{DS(\text{on})}$	$V_{GS} = 10V, I_D = 8A$	-	9.8	12	$\text{m}\Omega$
		$V_{GS} = 4.5V, I_D = 4A$	-	13.5	16	
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 15V, V_{GS} = 0V, f = 1\text{MHz}$	-	1140	-	$\text{pF}$
Output Capacitance	$C_{oss}$		-	175	-	
Reverse Transfer Capacitance	$C_{rss}$		-	151	-	
<b>Switching characteristics</b>						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 15V, I_D = 4A,$ $V_{GS} = 10V, R_G = 3\Omega$	-	15	-	$\text{ns}$
Turn-on rise time	$t_r$		-	19	-	
Turn-off delay time	$t_{d(off)}$		-	35	-	
Turn-off fall time	$t_f$		-	21	-	
Total Gate Charge	$Q_g$	$V_{DS} = 15V, I_D = 4A,$ $V_{GS} = 10V$	-	13.3	-	$\text{nC}$
Gate-Source Charge	$Q_{gs}$		-	3.1	-	
Gate-Drain Charge	$Q_{gd}$		-	5	-	
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage <sup>(2)</sup>	$V_{DS}$	$V_{GS} = 0V, I_S = 8A$	-	-	1.2	V
Diode Forward current <sup>(3)</sup>	$I_S$		-	-	8	A

**Notes:**

1. Repetitive Rating: pulse width limited by maximum junction temperature
2. Pulse Test: pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$
3. Surface Mounted on FR4 Board,  $t \leq 10$  sec

## Test Circuit

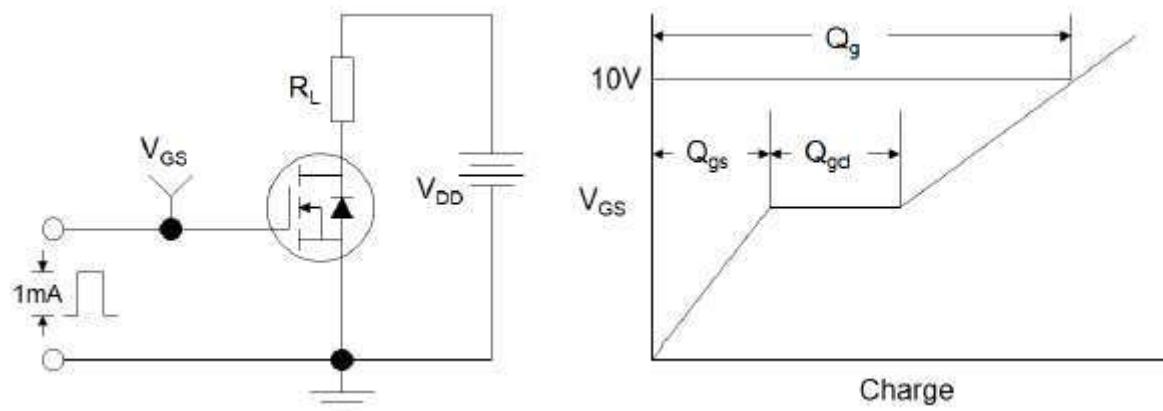


Figure1:Gate Charge Test Circuit & Waveform

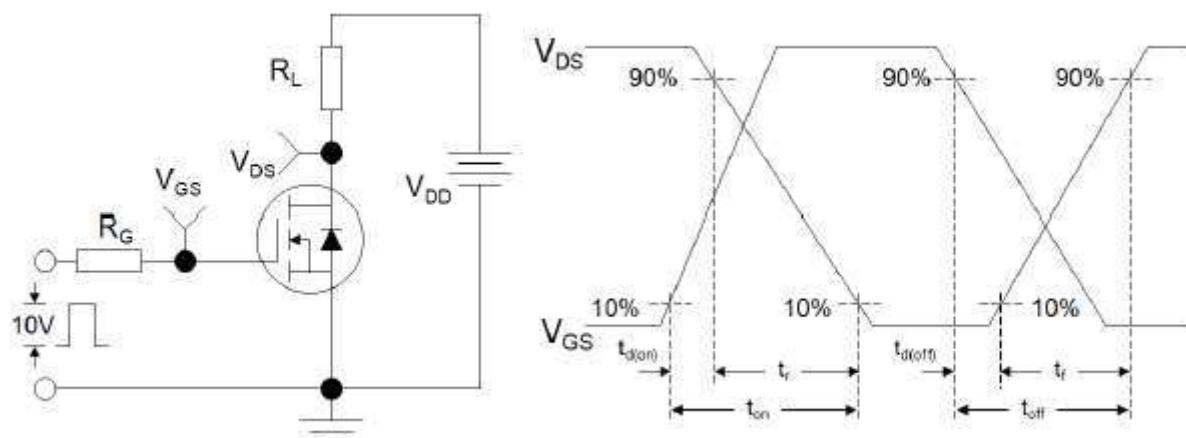


Figure 2: Resistive Switching Test Circuit & Waveforms

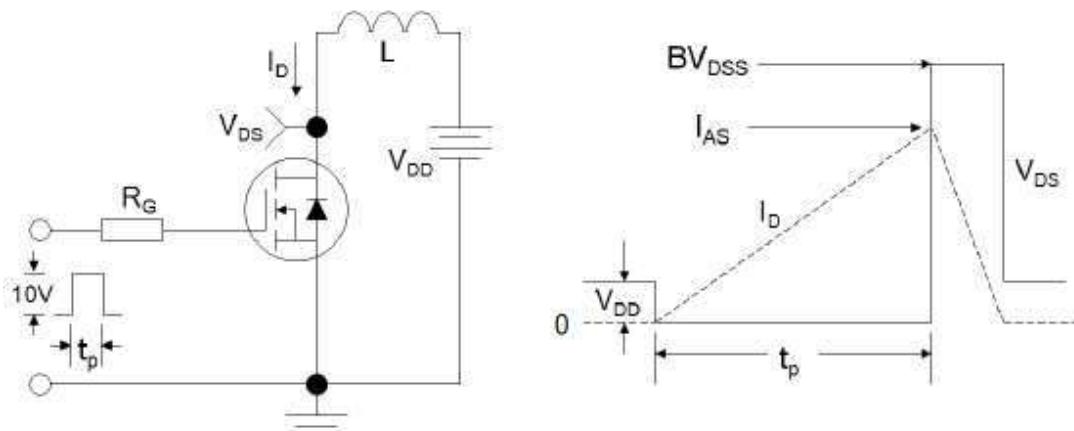
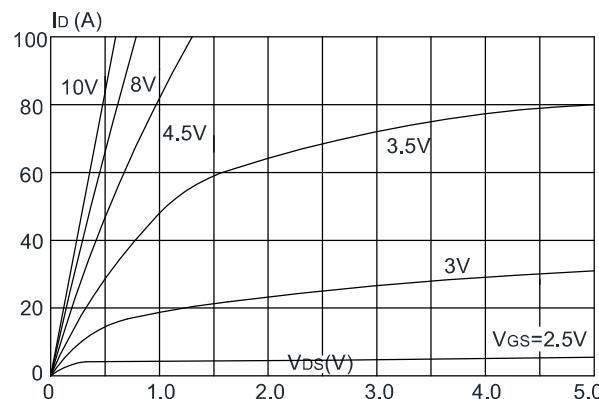


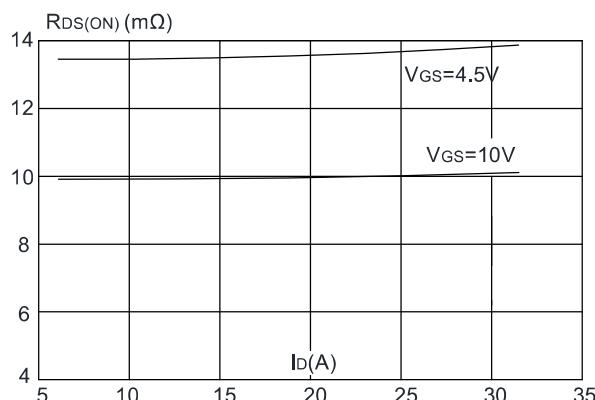
Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms

## Typical Performance Characteristics

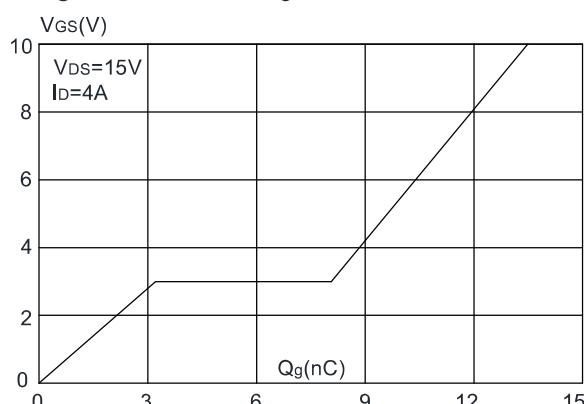
**Figure 1:** Output Characteristics



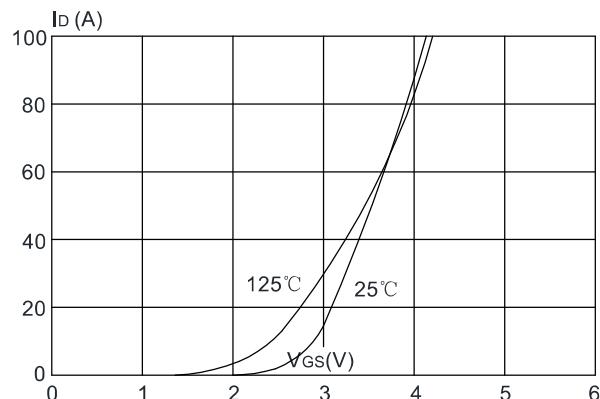
**Figure 3:** On-resistance vs. Drain Current



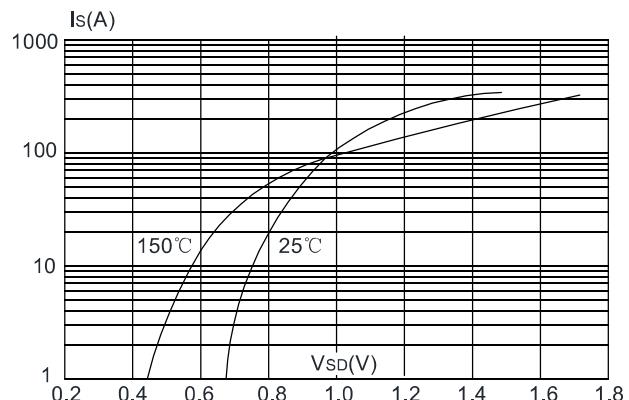
**Figure 5:** Gate Charge Characteristics



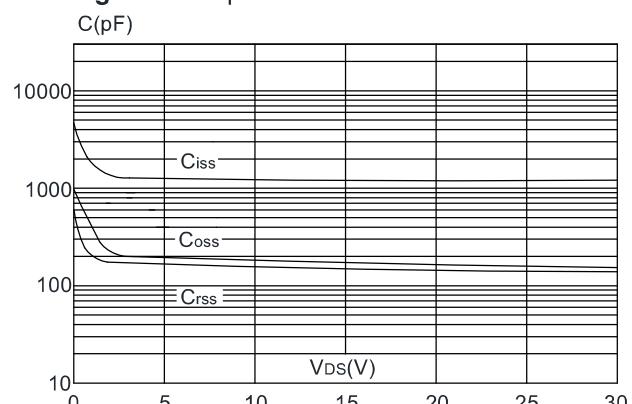
**Figure 2:** Typical Transfer Characteristics



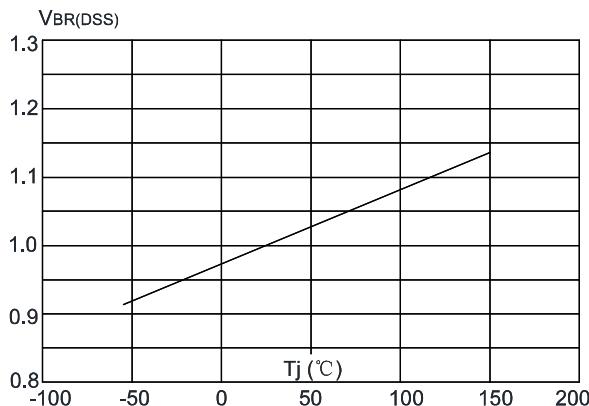
**Figure 4:** Body Diode Characteristics



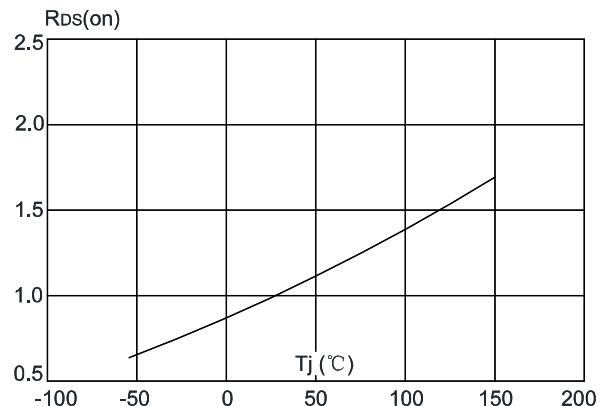
**Figure 6:** Capacitance Characteristics



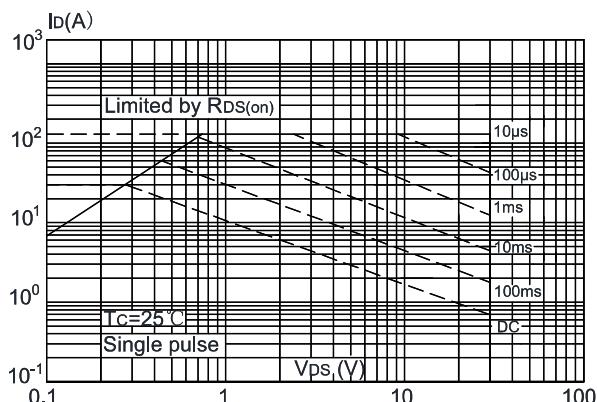
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



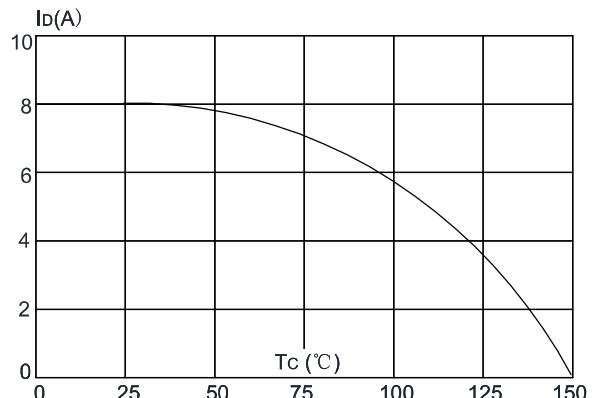
**Figure 8:** Normalized on Resistance vs. Junction Temperature



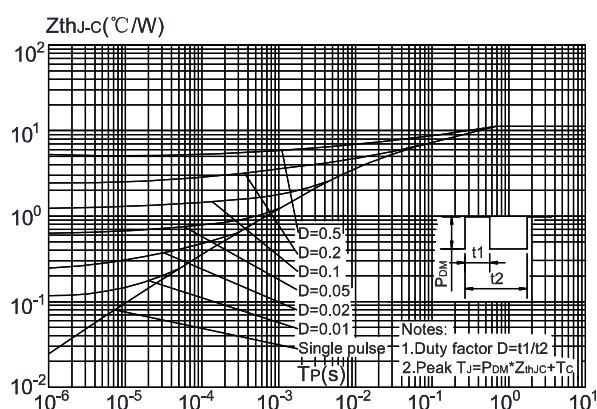
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature



**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case



## SOT-23-3 Package Information

